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### **General Description**

The MAX98306 stereo 3.7W Class D amplifier provides Class AB audio performance with Class D efficiency. This device offers five selectable gain settings (6dB, 9dB, 12dB, 15dB, and 18dB) set by a single gain-select input (GAIN).

Active emissions limiting, edge-rate, and overshoot control circuitry combined with a filterless spread-spectrum modulation scheme (SSM) provide excellent EMI performance while eliminating the need for output filtering found in traditional Class D devices. These features reduce application component count.

The IC's 2.0mA quiescent current with a 3.7V supply extends battery life in portable applications.

The IC is available in a 14-pin TDFN (3mm x 3mm x 0.75mm) package specified over the extended -40°C to +85°C temperature range.

### **Applications**

Smartphones	MPC
Tablets	Port
Cellular Phones	Voll

**Accessory Speakers** 

MP3 Players

table Audio Players

P Phones

#### **Features**

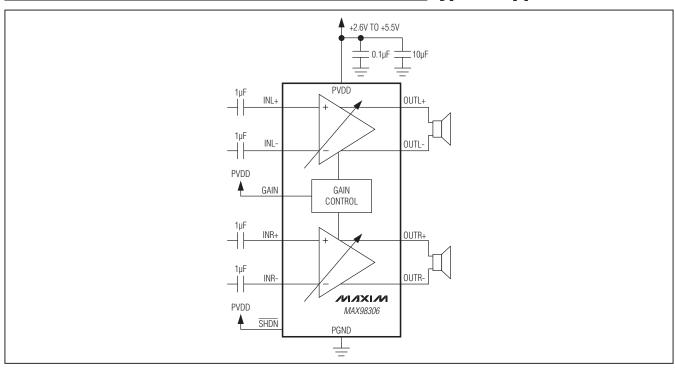
- ♦ Output Power 3.7W at  $3\Omega$ , 10% THD, 1.7W at  $8\Omega$ , 10% THD, with 5V Supply
- ♦ Passes EMI Limit Unfiltered with Up to 12in of Speaker Cable
- ♦ High 83dB PSRR at 217Hz
- **♦** Spread-Spectrum Modulation and Active **Emissions Limiting**
- ♦ Five Pin-Selectable Gains
- **♦** Excellent Click-and-Pop Suppression
- **♦ Thermal and Overcurrent Protection**
- ♦ Low-Current Shutdown Mode
- ♦ Space-Saving, 3mm x 3mm x 0.75mm, 14-Pin TDFN

#### **Ordering Information**

PART	TEMP RANGE	PIN- PACKAGE	TOP MARK
MAX98306ETD+	-40°C to +85°C	14 TDFN	+AEV

<sup>+</sup>Denotes a lead(Pb)-free/RoHS-compliant package.

## Typical Application Circuit



MIXIM

#### **ABSOLUTE MAXIMUM RATINGS**

Voltage
PVDD to PGND0.3V to +6V
OUTL+, OUTR+, OUTL-, OUTR-
to PGND0.3V to (V <sub>PVDD</sub> + 0.3V)
All Other Pins to PGND0.3V to +6V
Current
Continuous Current Into/Out of PVDD, PGND,
OUTL+, OUTR+, OUTL-, OUTR±800mA
Continuous Input Current (all other pins) ±20mA

Duration of Short Circuit	
OUTL+, OUTR+, OUTL-, OUTR- to PGND o	or PVDDContinuous
OUTL+ to OUTL- or OUTR+ to OUTR	Continuous
Continuous Power Dissipation for a MultiLayer	Board ( $T_A = +70^{\circ}C$ )
TDFN (deration 24.4mW/°C above +70°C	) 1951.2mW
Junction Temperature	+150°C
Operating Temperature Range	40°C to +85°C
Storage Temperature Range	
Lead Temperature (10s, soldering)	
Soldering Temperature (reflow)	+260°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### **PACKAGE THERMAL CHARACTERISTICS (Note 1)**

Junction-to-Ambient Thermal Resistance ( $\theta_{JA}$ ).......41°C/W Junction-to-Case Thermal Resistance ( $\theta_{JA}$ )......8°C/W

**Note 1:** Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to <a href="https://www.maxim-ic.com/thermal-tutorial">www.maxim-ic.com/thermal-tutorial</a>.

#### **ELECTRICAL CHARACTERISTICS**

 $(VPVDD = VSHDN = 3.7V, VPGND = 0V, AV = 12dB (GAIN = PVDD), R_L = \infty, R_L connected between OUT_+ to OUT_-, 20Hz to 22kHz AC measurement bandwidth, TA = TMIN to TMAX, unless otherwise noted. Typical values are at TA = +25°C.) (Note 2)$ 

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
GENERAL						
Supply Voltage Range	VPVDD	Guaranteed by PSRR test	2.6		5.5	V
Undervoltage Lockout	UVLO			1.8	2.3	V
Outage ant Cumply Current	l===	VPVDD = 3.7V		2	2.7	Λ
Quiescent Supply Current	IPVDD	$V_{PVDD} = 5.0V$		2.6		mA
Shutdown Supply Current	ISHDN	VSHDN = 0, TA = +25°C		< 1	10	μΑ
Turn On Time	ton			3.2	10	ms
Bias Voltage	VBIAS		1.62	V <sub>PVDD</sub> /2	2.15	V
		GAIN = PGND	17.5	18	18.5	
		GAIN = $100k\Omega$ to PGND	14.5	15	15.5	
Voltage Gain	Av	GAIN = PVDD	11.5	12	12.5	dB
		GAIN = 100k $\Omega$ to PVDD	8.5	9	9.5	
		GAIN = unconnected	5.5	6	6.5	
Channel-to-Channel Gain Tracking				0.1		%
		Av = 18dB (GAIN = PGND)	22	33		
		Av = 15Db (GAIN = $100k\Omega$ to PGND)	31	46		
Input Resistance	RIN	Av = 12dB (GAIN = PVDD)	44	65		kΩ
		Av = 9dB (GAIN = $100k\Omega$ to PVDD)	62	93		
		Ay = 6dB (GAIN = unconnected)	89	131		
Common-Mode Rejection Ratio	CMRR	f <sub>IN</sub> = 1kHz, input referred		79		dB
Output Offset Voltage	Vos	T <sub>A</sub> = +25°C (Note 3)		±1	±3	mV

### **ELECTRICAL CHARACTERISTICS (continued)**

 $(VPVDD = V\overline{SHDN} = 3.7V, VPGND = 0V, AV = 12dB (GAIN = PVDD), R_L = \infty, R_L connected between OUT_+ to OUT_-, 20Hz to 22kHz AC measurement bandwidth, TA = TMIN to TMAX, unless otherwise noted. Typical values are at TA = +25°C.) (Note 2)$ 

PARAMETER	SYMBOL	СО	NDITIONS	MIN	TYP	MAX	UNITS	
Click-and-Pop Level	KCP	Peak voltage, T <sub>A</sub> = A-weighted, 32 samper second (Notes	mples Out of abutdown		-79 -73		dBV	
			$V_{PVDD} = 2.6V \text{ to } 5.5V,$ $T_{A} = +25^{\circ}C$	70	95			
Power-Supply Rejection Ratio	PSRR	T <sub>A</sub> = +25°C	f = 217Hz, 200mV <sub>P-P</sub> ripple		83		dB	
rower-supply nejection natio	Ponn	(Note 3)	f = 1kHz, 200mVp-p ripple		83		ив	
			f = 10kHz, 200mVp-p ripple		77			
			$Z_{SPK} = 3\Omega + 22\mu H,$ $V_{PVDD} = 5.0V$		3.7			
		THD+N = 10%	$Z_{SPK} = 4\Omega + 33\mu H,$ $V_{PVDD} = 5.0V$		3			
	Pout  THD+N =	IDD+N = 10%	$Z_{SPK} = 8\Omega + 68\mu H,$ $V_{PVDD} = 5.0V$		1.7			
			$Z_{SPK} = 8\Omega + 68\mu H,$ $V_{PVDD} = 3.7V$		0.9		- W	
Output Power			$Z_{SPK} = 3\Omega + 22\mu H,$ $V_{PVDD} = 5.0V$		2.9			
			TUD N 10/	$Z_{SPK} = 4\Omega + 33\mu H,$ $V_{PVDD} = 5.0V$		2.4		
		1HD+N = 1%	$Z_{SPK} = 8\Omega + 68\mu H$ $V_{PVDD} = 5.0V$		1.4			
			$Z_{SPK} = 8\Omega + 68\mu H$ $V_{PVDD} = 3.7V$		0.75			
	IS fini :		$Z_{SPK} = 3\Omega + 22\mu H,$ $P_{OUT} = 1.6W,$ $P_{VDD} = 5.0V$		0.05			
Total Harmonic Distortion Plus Noise		f <sub>IN</sub> = 1kHz	$Z_{SPK} = 4\Omega + 33\mu H,$ $P_{OUT} = 650 \text{mW},$ $P_{VDD} = 3.7 \text{V}$		0.05	0.75	0/	
	THD+N	T <sub>A</sub> = +25°C	$Z_{SPK} = 4\Omega + 33\mu H,$ $P_{OUT} = 1.3W,$ $V_{PVDD} = 5.0V$		0.04		%	
			$Z_{SPK} = 8\Omega + 68\mu H,$ $P_{OUT} = 725mW,$ $P_{VDD} = 5.0V$		0.03			
Output Noise		A-weighted (Note	3)		29		μVRMS	

#### **ELECTRICAL CHARACTERISTICS (continued)**

 $(V_{PVDD} = V_{\overline{SHDN}} = 3.7V, V_{PGND} = 0V, A_V = 12dB (GAIN = PVDD), R_L = \infty, R_L connected between OUT_+ to OUT_-, 20Hz to 22kHz AC measurement bandwidth, T_A = T_{MIN} to T_{MAX}, unless otherwise noted. Typical values are at T_A = +25°C.) (Note 2)$ 

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Signal-to-Noise Ratio	SNR	$Z_{SPK} = 8Ω + 68μH$ , $P_{OUT}$ at 1% THD+N		99		dB
Efficiency	η	$Z_{SPK} = 8\Omega + 68\mu H$ , $P_{OUT} = 1.4W$ , $f = 1kHz$		92		%
Oscillator Frequency	fosc		160	320	540	kHz
Spread-Spectrum Bandwidth				20		kHz
Current Limit		$T_A = +25^{\circ}C$		3		А
Thermal-Shutdown Level				+150		°C
Thermal Hysteresis				20		°C
DIGITAL INPUT (SHDN)						
Input-Voltage High	VIH		1.4			V
Input-Voltage Low	VIL				0.4	V
Input Leakage Current		$T_A = +25$ °C, $\overline{SHDN} = 0$			±1	μΑ

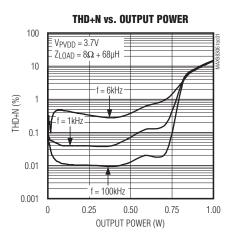
**Note 2:** This device is 100% production tested at  $T_A = +25$ °C. All temperature limits are guaranteed by design.

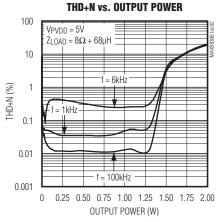
Note 3: Amplifier inputs AC-coupled to ground.

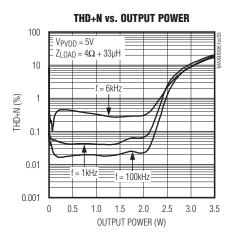
Note 4: Specified at room temperature with an  $8\Omega$  resistive load in series with a  $68\mu H$  inductive load.

## Typical Operating Characteristics

 $(V_{PVDD} = V_{\overline{SHDN}} = 5.0V, V_{PGND} = 0V, AV = 12dB, R_L = \infty, R_L connected between OUT_+ to OUT_-, 20Hz to 22kHz AC measurement bandwidth, T_A = +25°C, unless otherwise noted.)$ 

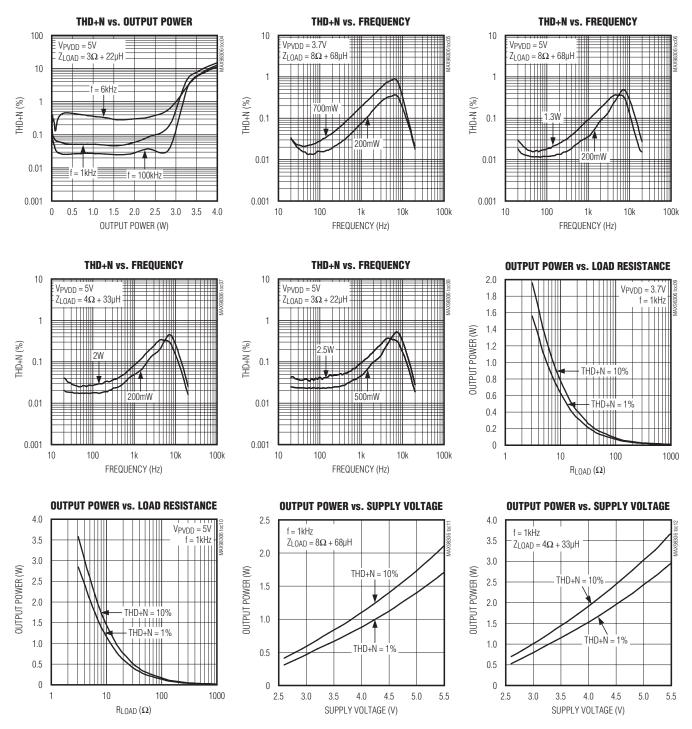






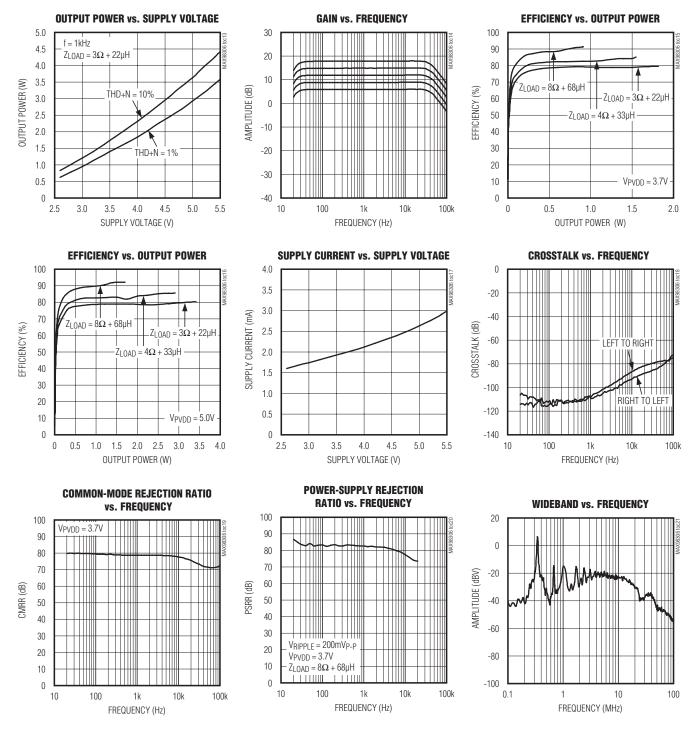
### **Typical Operating Characteristics (continued)**

 $(V_{PVDD} = V_{\overline{SHDN}} = 5.0V, V_{PGND} = 0V, AV = 12dB, R_L = \infty, R_L connected between OUT_+ to OUT_-, 20Hz to 22kHz AC measurement bandwidth, TA = +25°C, unless otherwise noted.)$ 



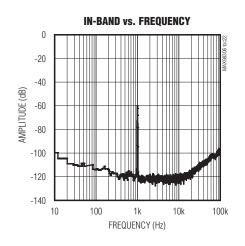
### **Typical Operating Characteristics (continued)**

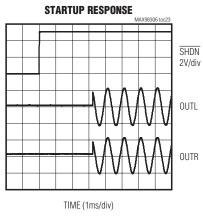
 $(VPVDD = V\overline{SHDN} = 5.0V, VPGND = 0V, AV = 12dB, RL = \infty, RL connected between OUT_+ to OUT_-, 20Hz to 22kHz AC measurement bandwidth, TA = +25°C, unless otherwise noted.)$ 

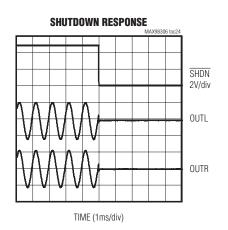


### **Typical Operating Characteristics (continued)**

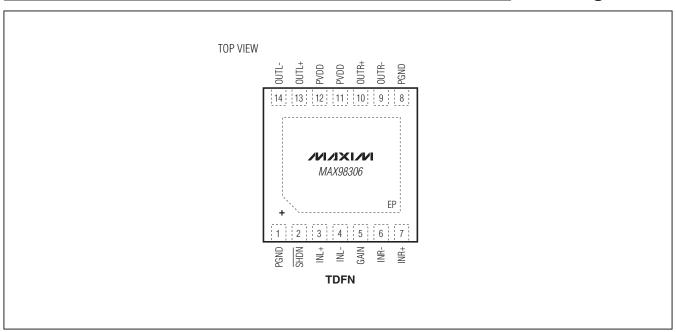
 $(VPVDD = V\overline{SHDN} = 5.0V, VPGND = 0V, AV = 12dB, R_L = \infty, R_L connected between OUT_+ to OUT_-, 20Hz to 22kHz AC measurement bandwidth, TA = +25°C, unless otherwise noted.)$ 







## **Pin Configuration**



## Pin Description

PIN	NAME	FUNCTION	
1, 8	PGND	Ground	
2	SHDN	Active-Low Shutdown Input. Drive SHDN to PGND to place the device into shutdown. Drive SHDN above 1.4V for normal operation.	
3	INL+	Noninverting Audio Left Input	
4	INL-	Inverting Audio Left Input	
5	GAIN	Gain Select	
6	INR-	Inverting Audio Right Input	
7	INR+	Noninverting Audio Right Input	
9	OUTR-	Negative Right Speaker Output	
10	OUTR+	Positive Right Speaker Output	
11, 12	PVDD	Power Supply. Bypass PVDD to PGND with a 0.1µF capacitor in parallel with a 10µF capacitor placed as close as possible to the device.	
13	OUTL+	Positive Left Speaker Output	
14	OUTL-	Negative Left Speaker Output	
_	EP	Exposed Pad. Connect the exposed pad directly to ground.	

#### **Detailed Description**

The MAX98306 features low quiescent current, a low-power shutdown mode, comprehensive click-and-pop suppression, and excellent RF immunity.

The IC offers Class AB audio performance with Class D efficiency in a minimal board-space solution.

The Class D amplifier features spread-spectrum modulation, active emissions limiting, edge-rate, and overshoot control circuitry that offers significant improvements to switch-mode amplifier radiated emissions.

The amplifier also features click-and-pop suppression that reduces audible transients on startup and shutdown, as well as thermal-overload and short-circuit protection.

#### **Class D Speaker Amplifier**

The filterless Class D amplifier output stage offers much higher efficiency than Class AB amplifiers. The high efficiency of a Class D amplifier is due to the pulse-width modulated (PWM) rail-to-rail switching operation of the output stage transistors. This ensures that any power loss associated with the Class D output stage is mostly due to the I<sup>2</sup>R loss of the MOSFET on-resistance and quiescent current overhead.

#### EMI Filterless Output Stage

Traditional Class D amplifiers require the use of external LC filters, or shielding, to meet EN55022B electromagnetic-interference (EMI) regulation standards. Maxim's active-emissions-limiting edge-rate control circuitry and spread-spectrum modulation reduce EMI emissions, while maintaining up to 92% efficiency.

Spread-spectrum modulation and active emissions limiting limit wideband spectral components, while proprietary techniques ensure that the cycle-to-cycle variation of the switching period does not degrade audio reproduction or efficiency. The IC's spread-spectrum modulator randomly varies the switching frequency by ±20kHz around the center frequency (320kHz). Above 10MHz, the wideband spectrum looks like noise for EMI purposes (Figure 1).

#### Speaker Current Limit

If the output current of the speaker amplifier exceeds the current limit (3A typ), the IC disables the outputs for approximately 100µs. At the end of 100µs, the outputs are reenabled. If the fault condition still exists, the IC continues to disable and reenable the outputs until the fault condition is removed.

**Table 1. Gain Control Configuration** 

GAIN PIN	MAXIMUM GAIN (dB)
Connect to PGND	18
Connect to PGND through $100 \text{k}\Omega$ $\pm 5\%$ resistor	15
Connect to PVDD	12
Connect to PVDD through 100kΩ ±5% resistor	9
Unconnected	6

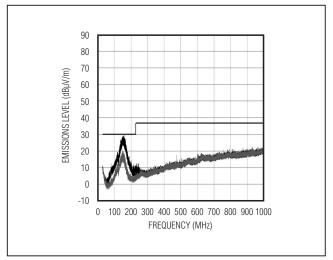


Figure 1. EMI with 12in of Speaker Cable and No Output Filter

#### Selectable Gain

The IC offers five programmable gains selected using the GAIN input.

#### **Shutdown**

The IC features a low-power shutdown mode, drawing  $\leq 1 \mu A$  (typ) of supply current. Drive  $\overline{SHDN}$  low to place the MAX98306 into shutdown. Drive  $\overline{SHDN}$  above 1.4V for normal operation.

#### **Click-and-Pop Suppression**

The IC speaker amplifier features Maxim's comprehensive click-and-pop suppression. During startup, the click-and-pop suppression circuitry reduces any audible transient sources internal to the device. When entering shutdown, the differential speaker outputs ramp down to PGND quickly and simultaneously.

### Applications Information

#### Filterless Class D Operation

Traditional Class D amplifiers require an output filter. The filter adds cost and size and decreases THD performance. The IC's filterless modulation scheme does not require an output filter.

Because the switching frequency of the IC is well beyond the bandwidth of most speakers, voice coil movement due to the switching frequency is very small. Use a speaker with a series inductance > 10 $\mu$ H. Typical 8 $\Omega$  speakers exhibit series inductances in the 20 $\mu$ H to 100 $\mu$ H range.

# **Component Selection**Power-Supply Input (PVDD)

PVDD powers the speaker amplifier. PVDD ranges from 2.6V to 5.5V. Bypass PVDD with 0.1µF and 10µF capacitors to PGND. Apply additional bulk capacitance at the device if long input traces between PVDD and the power source are used.

#### Input Filtering

The input-coupling capacitor (C<sub>IN</sub>), in conjunction with the amplifier's internal input resistance (R<sub>IN</sub>), forms a highpass filter that removes the DC bias from the incoming signal. These capacitors allow the amplifier to bias the signal to an optimum DC level.

Assuming zero source impedance, CIN is:

$$C_{IN} = \frac{1}{2\pi f_{-3dB} \times R_{IN}}$$

where  $f_{-3dB}$  is the -3dB corner frequency and  $R_{IN}$  is the typical value as specified in the *Electrical Characteristics* table. Use capacitors with adequately low-voltage coefficients for best low-frequency THD performance. Table 2 shows calculated capacitance values based on a 20Hz highpass filter.

Table 2. Capacitance Value for 20Hz Highpass Filter

GAIN	Pm (ko)	Cut for 20Hz (nE)
GAIN	R <sub>IN</sub> (kΩ)	C <sub>IN</sub> for 20Hz (nF)
18	33	241
15	46	173
12	65	122
9	93	86
6	131	61

#### **Layout and Grounding**

Proper layout and grounding are essential for optimum performance. Good grounding improves audio performance and prevents switching noise from coupling into the audio signal.

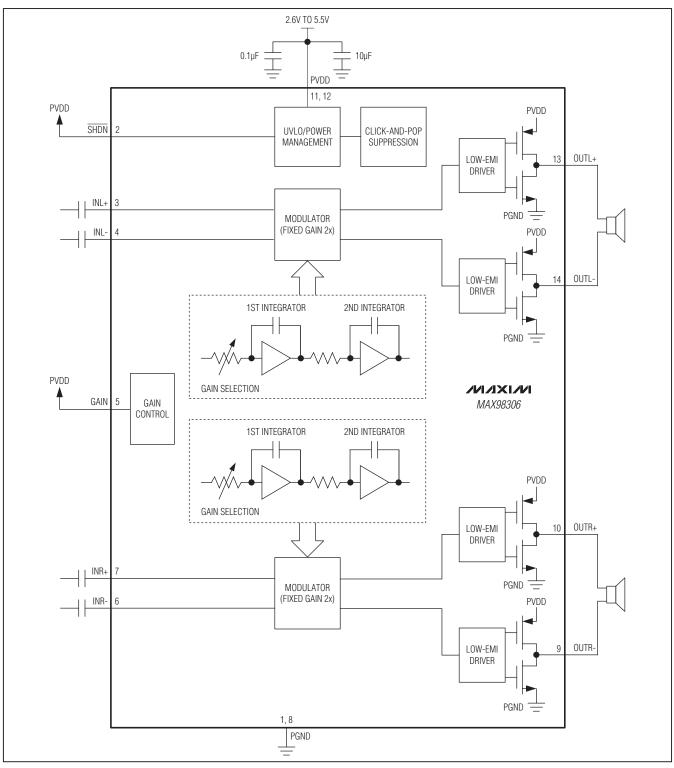
Use wide, low-resistance output traces. As the load impedance decreases, the current drawn from the device increases. At higher current, the resistance of the output traces decrease the power delivered to the load. For example, if 2W is delivered from the device output to a  $4\Omega$  load through  $100m\Omega$  of total speaker trace, 1.904W is delivered to the speaker. If power is delivered through  $10m\Omega$  of total speaker trace, 1.99W is delivered to the speaker. Wide output, supply, and ground traces also improve the power dissipation of the device.

The IC is inherently designed for excellent RF immunity. For best performance, add ground fills around all signal traces on top or bottom PCB planes.

**Chip Information** 

PROCESS: CMOS

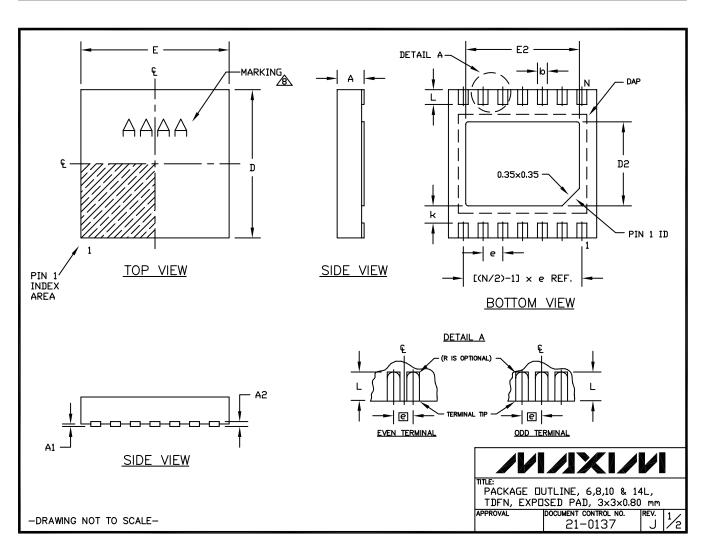
### Block Diagram



### **Package Information**

For the latest package outline information and land patterns (footprints), go to <a href="www.maxim-ic.com/packages">www.maxim-ic.com/packages</a>. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE TYPE	PACKAGE CODE	OUTLINE NO.	LAND PATTERN NO.
14 TDFN	T1433+2	<u>21-0137</u>	90-0063



#### Package Information (continued)

For the latest package outline information and land patterns (footprints), go to <a href="www.maxim-ic.com/packages">www.maxim-ic.com/packages</a>. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

COMMON DIMENSIONS				
SYMBOL	MIN.	MAX.		
Α	0.70	0.80		
D	2.90	3.10		
E	2.90	3.10		
A1	0.00	0.05		
L	0.20	0.40		
k	0.25 MIN.			
A2	0.20 REF.			

PACKAGE VARIATIONS								
PKG. CODE	N	D2	E2	е	JEDEC SPEC	b	[(N/2)-1] x e	
T633-2	6	1.50±0.10	2.30±0.10	0.95 BSC	MO229 / WEEA	0.40±0.05	1.90 REF	
T833-2	8	1.50±0.10	2.30±0.10	0.65 BSC	MO229 / WEEC	0.30±0.05	1.95 REF	
T833-3	8	1.50±0.10	2.30±0.10	0.65 BSC	MO229 / WEEC	0.30±0.05	1.95 REF	
T1033-1	10	1.50±0.10	2.30±0.10	0.50 BSC	MO229 / WEED-3	0.25±0.05	2.00 REF	
T1033MK-1	10	1.50±0.10	2.30±0.10	0.50 BSC	MO229 / WEED-3	0.25±0.05	2.00 REF	
T1033-2	10	1.50±0.10	2.30±0.10	0.50 BSC	MO229 / WEED-3	0.25±0.05	2.00 REF	
T1433-1	14	1.70±0.10	2.30±0.10	0.40 BSC		0.20±0.05	2.40 REF	
T1433-2	14	1.70±0.10	2.30±0.10	0.40 BSC		0.20±0.05	2.40 REF	
T1433-3F	14	1.70±0.10	2.30±0.10	0.40 BSC		0.20±0.05	2.40 REF	

#### NOTES:

- 1. ALL DIMENSIONS ARE IN mm. ANGLES IN DEGREES.
- 2. COPLANARITY SHALL NOT EXCEED 0.08 mm.
- 3. WARPAGE SHALL NOT EXCEED 0.10 mm.
- 4. PACKAGE LENGTH/PACKAGE WIDTH ARE CONSIDERED AS SPECIAL CHARACTERISTIC(S).
- 5. DRAWING CONFORMS TO JEDEC MO229, EXCEPT DIMENSIONS "D2" AND "E2", AND T1433-1 & T1433-2.
- 6. "N" IS THE TOTAL NUMBER OF LEADS.
- 7. NUMBER OF LEADS SHOWN ARE FOR REFERENCE ONLY.
- & MARKING IS FOR PACKAGE ORIENTATION REFERENCE ONLY.
- 9. ALL DIMENSIONS APPLY TO BOTH LEADED (-) AND PbFREE (+) PKG. CODES.



-DRAWING NOT TO SCALE-

## **Revision History**

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	6/11	Initial release	_
1	8/11	Updated output power in Electrical Characteristics	3